



MOSFET

OptiMOS[™]5 Power-Transistor, 100 V

Features

- Optimized for low voltage motor drives application
 Optimized for battery powered applications
 Enables automated optical solder inspection

- 100% avalanche tested
- N-channel
- 175°C rated
- Pb-free lead plating : RoHS compliant

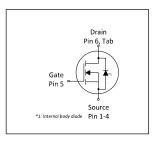
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	100	V
R _{DS(on),max}	2.6	mΩ
ID	248	A
Q _{oss}	154	nC
Q _G (0V10V)	89	nC









Type / Ordering Code	Package	Marking	Related Links
IST026N10NM5	sTOLL	026N10N5	-



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	4
Electrical characteristics diagrams	6
Package Outlines	0
Revision History	1
Trademarks	1
Disclaimer	1



1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Devenueter	Course had	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	248 175 27	A		
Pulsed drain current ³⁾	I _{D,pulse}	-	-	992	A	<i>T</i> _c =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	326	mJ	I _D =100 A, R _{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	313 3.8	W	T_{c} =25 °C T_{A} =25 °C, R_{THJA} =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Parameter	Symbol	Values			11	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.3	0.48	°C/W	-	
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	40	°C/W	-	

⁴⁾ See Diagram 13 for more detailed information

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air. ³⁾ See Diagram 3 for more detailed information



3 **Electrical characteristics**

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

Devenueter	Sumbal	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	100	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	-	3.8	V	V _{DS} =V _{GS} , <i>I</i> _D =148 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	5 100	μA	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.1 2.6	2.6 3.5	mΩ	V _{GS} =10 V, <i>I</i> _D =100 A V _{GS} =6 V, <i>I</i> _D =50 A
Gate resistance ¹⁾	R _G	-	0.8	-	Ω	-
Transconductance	g_{fs}	140	210	-	S	<i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =100 A

Dynamic characteristics Table 5

Devenenter	Ourseland	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	6300	-	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	980	-	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	43	-	pF	V _{GS} =0 V, V _{DS} =50 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	24	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	29	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\rm d(off)}$	-	43	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	10	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	0h.a.l	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	30	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	19	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate to drain charge	Q _{gd}	-	18	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Switching charge	Qsw	-	29	-	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	89	125	nC	V_{DD} =50 V, I_{D} =100 A, V_{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.7	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Qg(sync)	-	78	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	154	-	nC	V _{DS} =100 V, V _{GS} =0 V

 ¹⁾ Defined by design. Not subject to production test.
 ²⁾ See "Gate charge waveforms" for parameter definition

OptiMOS[™]5 Power-Transistor, 100 V IST026N10NM5



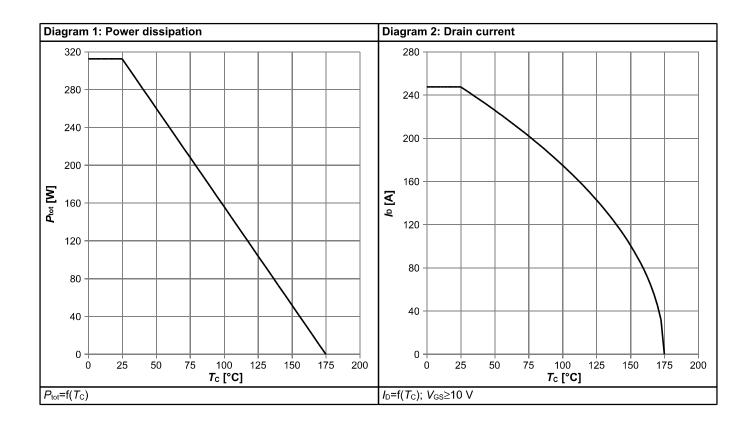
Table 7Reverse diode

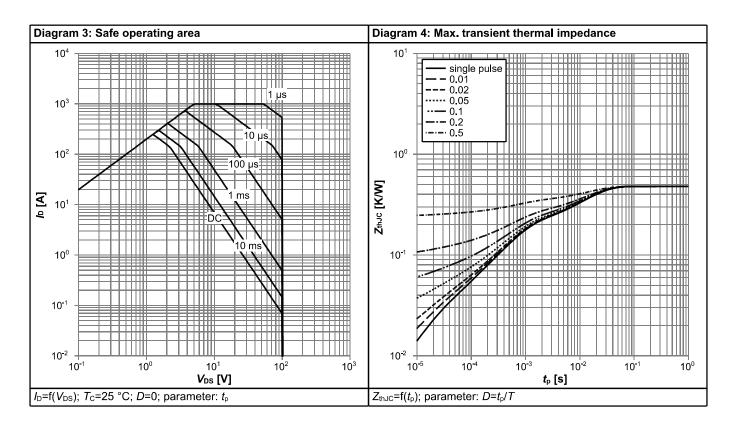
Parameter	Symbol	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	245	A	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	992	A	<i>T</i> _C =25 °C
Diode forward voltage V _{SD}		-	0.9	1.1	V	V _{GS} =0 V, <i>I</i> _F =100 A, <i>T</i> _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	51	-	ns	V _R =50 V, <i>I</i> _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/µs
Reverse recovery charge ¹⁾	Q _{rr}	-	75	-	nC	V _R =50 V, <i>I</i> _F =100 A, d <i>i</i> _F /d <i>t</i> =100 A/µs

¹⁾ Defined by design. Not subject to production test.

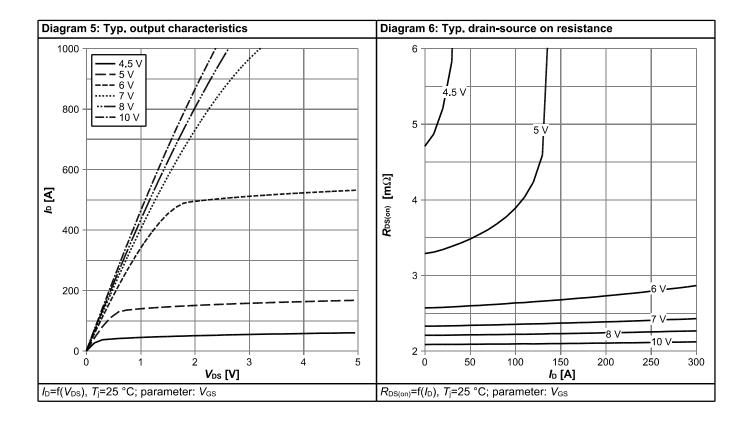


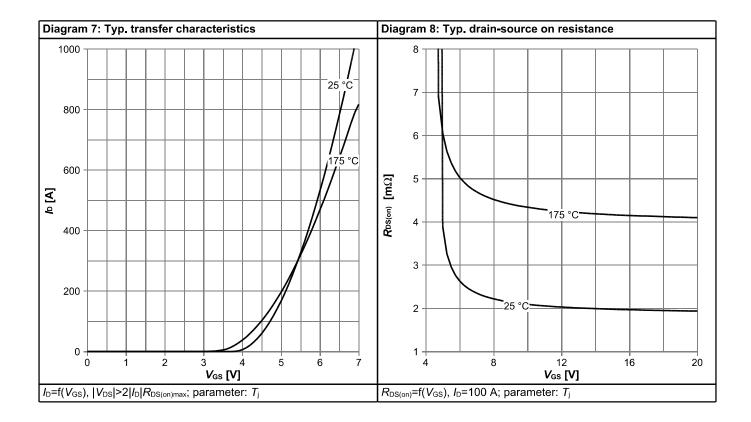
4 Electrical characteristics diagrams



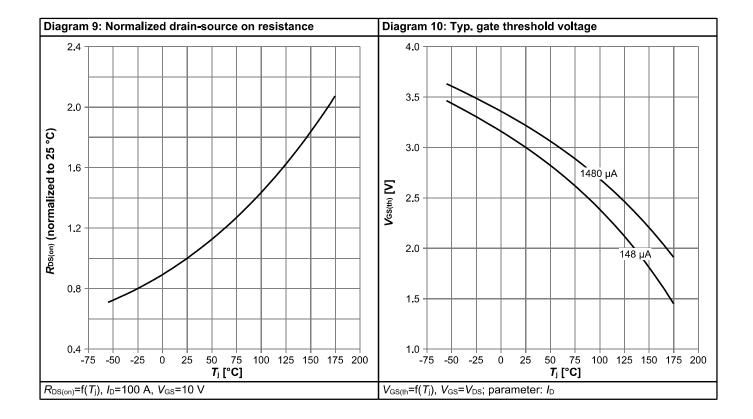


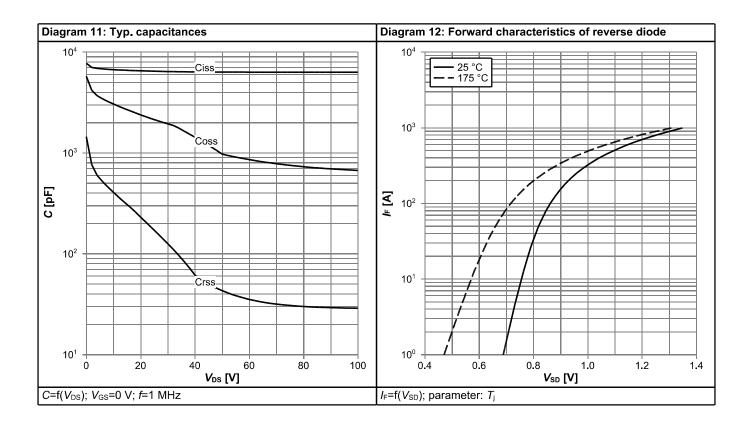




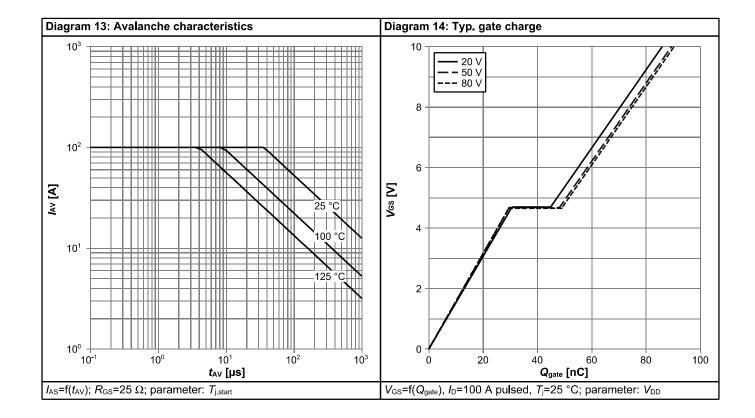


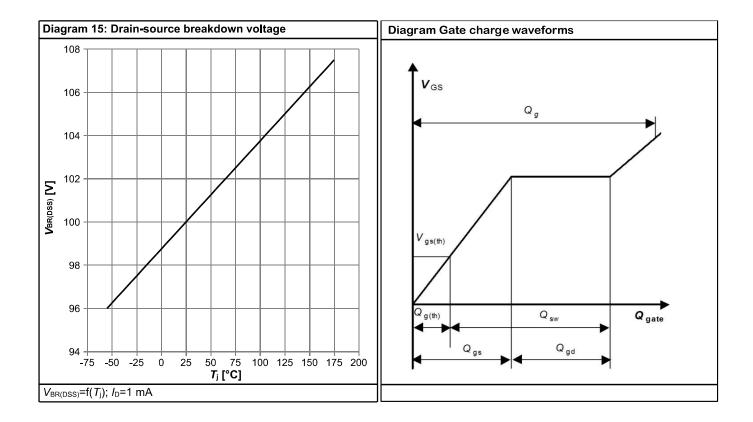






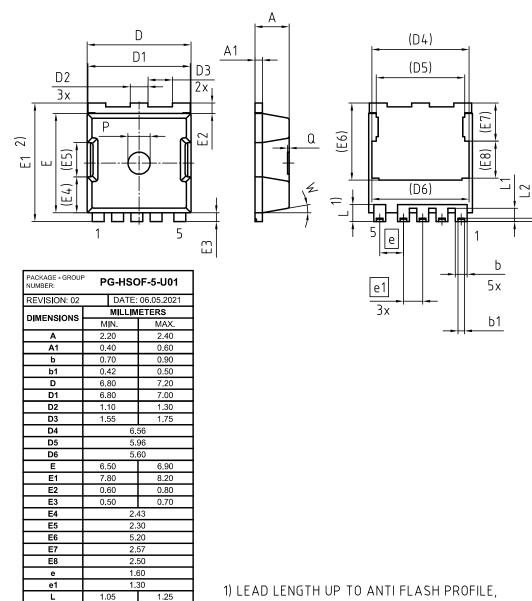








5 Package Outlines



MOLD FLASHES EXCLUDED.

2) EXCLUDING BURR

Figure 1 Outline sTOLL, dimensions in mm

0.80

0.13

1.40

0.00

8.50°

1.00

0.33

1.60

0.10

11.50°

L1

L2

Ρ

Q

w



Revision History

IST026N10NM5

Revision: 2022-01-24, Rev. 2.1

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2020-11-20	Release of final version				
2.1	2022-01-24	Update Part Marking				

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